9 R20UT

- **Operates With Single 5-V Power Supply**
- **LinBiCMOS™ Process Technology**
- Two Drivers and Two Receivers
- ±30-V Input Levels
- Low Supply Current . . . 8 mA Typical
- Meets or Exceeds TIA/EIA-232-F and ITU **Recommendation V.28**
- Designed to be Interchangeable With Maxim MAX232
- **Applications**

TIA/EIA-232-F **Battery-Powered Systems Terminals** Modems Computers

- **ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015**
- **Package Options Include Plastic** Small-Outline (D, DW) Packages and Standard Plastic (N) DIPs

description

The MAX232 device is a dual driver/receiver that includes a capacitive voltage generator to supply EIA-232 voltage levels from a single 5-V supply. Each receiver converts EIA-232 inputs to 5-V TTL/CMOS levels. These receivers have a typical threshold of 1.3 V and a typical hysteresis of 0.5 V, and can accept ±30-V inputs. Each driver converts TTL/CMOS input levels into EIA-232 levels. The driver, receiver, and voltage-generator functions are available as cells in the Texas Instruments LinASIC™ library.

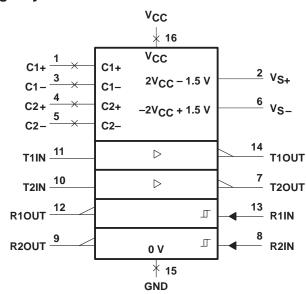
The MAX232 is characterized for operation from 0°C to 70°C. The MAX232I is characterized for operation from -40°C to 85°C.

(TOP VIEW) 16∏ V_{CC} 15 GND V_{S+} [] 2 C1− ¶ 3 14 T10UT C2+ ¶ 4 13 **∏** R1IN C2- 1 5 12 T R10UT 11 T1IN V_{S-} 10 T2IN T20UT **[**] 7

R2IN ∏

D. DW. OR N PACKAGE

logic symbol†



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

AVAILABLE OPTIONS

		PACKAGED DEVICES	
TA	SMALL OUTLINE (D)	SMALL OUTLINE (DW)	PLASTIC DIP (N)
0°C to 70°C	MAX232D‡	MAX232DW [‡]	MAX232N
-40°C to 85°C	MAX232ID [‡]	MAX232IDW [‡]	MAX232IN

[‡]This device is available taped and reeled by adding an R to the part number (i.e., MAX232DR).



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SLLS047G - FEBRUARY 1989 - REVISED AUGUST 1998

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Input supply voltage range, V _{CC} (see Note 1)	0.3 V to 6 V
Positive output supply voltage range, V _{S+}	$V_{CC} - 0.3 \text{ V to } 15 \text{ V}$
Negative output supply voltage range, V _S	0.3 V to -15 V
Input voltage range, V _I : Driver	$-0.3 \text{ V to V}_{CC} + 0.3 \text{ V}$
Receiver	±30 V
Output voltage range, V _O : T1OUT, T2OUT	$V_{S-}-0.3 \text{ V to } V_{S+}+0.3 \text{ V}$
R10UT, R20UT	$-0.3 \text{ V to V}_{CC} + 0.3 \text{ V}$
Short-circuit duration: T1OUT, T2OUT	
Package thermal impedance, θ_{JA} (see Note 2): D package	113°C/W
DW package	105°C/W
N package	78°C/W
Storage temperature range, T _{stg}	–65°C to 150°C
Lead temperature 1.6 mm (1/16 inch) from case for 10 seconds	260°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: All voltage values are with respect to network ground terminal.

recommended operating conditions

		MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}		4.5	5	5.5	V
High-level input voltage, V _{IH} (T1IN,T2IN)		2			V
Low-level input voltage, V _{IL} (T1IN, T2IN)				0.8	V
Receiver input voltage, R1IN, R2IN				±30	V
Operating free cir temperature T.	MAX232	0		70	°C
Operating free-air temperature,T _A	MAX232I	-40		85	



^{2.} The package thermal impedance is calculated in accordance with JESD 51, except for through-hole packages, which use a trace length of zero.

electrical characteristics over recommended ranges of supply voltage and operating free-air temperature range (unless otherwise noted)

	PARAMETER		TEST CO	ONDITIONS	MIN	TYP [†]	MAX	UNIT
\/a	Lligh lovel output voltage	T1OUT, T2OUT	$R_L = 3 \text{ k}\Omega \text{ to GND}$)	5	7		V
VOH	High-level output voltage	R1OUT, R2OUT	$I_{OH} = -1 \text{ mA}$		3.5			V
Vai	Lava laval autout valta na t	T1OUT, T2OUT	$R_L = 3 \text{ k}\Omega \text{ to GND}$)		-7	– 5	V
VOL Low-level output voltage‡		R1OUT, R2OUT	I _{OL} = 3.2 mA				0.4	V
V _{IT+}	Receiver positive-going input threshold voltage	R1IN, R2IN	V _{CC} = 5 V,	T _A = 25°C		1.7	2.4	V
VIT-	Receiver negative-going input threshold voltage	R1IN, R2IN	V _{CC} = 5 V,	T _A = 25°C	0.8	1.2		٧
V _{hys}	Input hysteresis voltage	R1IN, R2IN	V _{CC} = 5 V		0.2	0.5	1	V
rį	Receiver input resistance	R1IN, R2IN	V _{CC} = 5,	T _A = 25°C	3	5	7	kΩ
r _O	Output resistance	T1OUT, T2OUT	$V_{S+} = V_{S-} = 0,$	V _O = ± 2 V	300			Ω
los§	Short-circuit output current	T1OUT, T2OUT	$V_{CC} = 5.5 \text{ V},$	V _O = 0		±10		mA
I _{IS}	Short-circuit input current	T1IN, T2IN	V _I = 0				200	μΑ
Icc	Supply current		V _{CC} = 5.5 V, T _A = 25°C	All outputs open,		8	10	mA

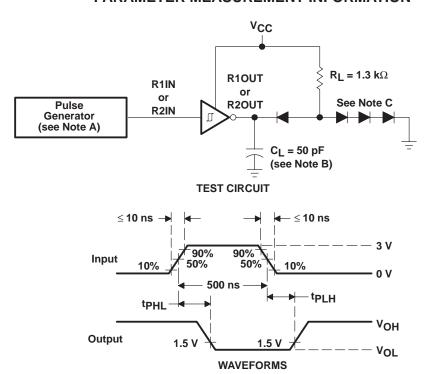
switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

	PARAMETER	TEST CONDITIONS	MIN TYP	MAX	UNIT
tPLH(R)	Receiver propagation delay time, low- to high-level output	See Figure 1	500		ns
tPHL(R)	Receiver propagation delay time, high- to low-level output	See Figure 1	500		ns
SR	Driver slew rate	R_L = 3 kΩ to 7 kΩ, See Figure 2		30	V/µs
SR(tr)	Driver transition region slew rate	See Figure 3	3		V/µs

[†] All typical values are at V_{CC} = 5 V, T_A = 25°C. ‡ The algebraic convention, in which the least positive (most negative) value is designated minimum, is used in this data sheet for logic voltage levels only.

[§] Not more than one output should be shorted at a time.

PARAMETER MEASUREMENT INFORMATION

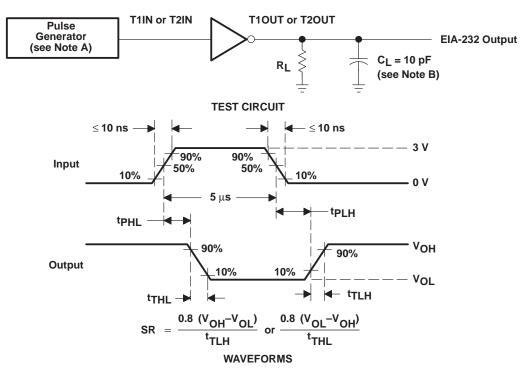


NOTES: A. The pulse generator has the following characteristics: $Z_0 = 50 \Omega$, duty cycle $\leq 50\%$.

- B. C_L includes probe and jig capacitance.
- C. All diodes are 1N3064 or equivalent.

Figure 1. Receiver Test Circuit and Waveforms for t_{PHL} and t_{PLH} Measurements

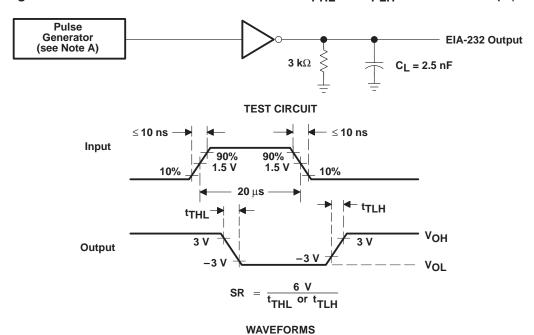
PARAMETER MEASUREMENT INFORMATION



NOTES: A. The pulse generator has the following characteristics: $Z_{\Omega} = 50 \Omega$, duty cycle $\leq 50\%$.

B. C_L includes probe and jig capacitance.

Figure 2. Driver Test Circuit and Waveforms for t_{PHL} and t_{PLH} Measurements (5-μs input)



NOTE A: The pulse generator has the following characteristics: $Z_0 = 50 \Omega$, duty cycle $\leq 50\%$.

Figure 3. Test Circuit and Waveforms for $t_{\mbox{\scriptsize THL}}$ and $t_{\mbox{\scriptsize TLH}}$ Measurements (20- $\!\mu\mbox{\scriptsize s}$ input)



APPLICATION INFORMATION

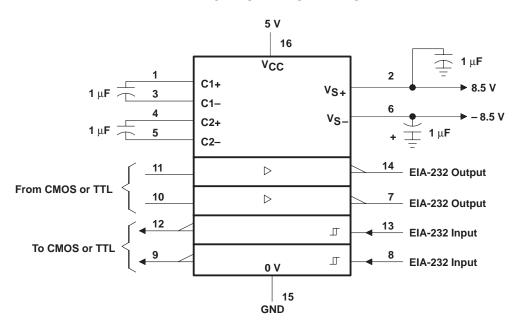


Figure 4. Typical Operating Circuit

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